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- Two Complete PWM Control Circuits
- Outputs Drive MOSFETs Directly
- Oscillator Frequency . . . 50 kHz to 2 MHz
- 3.6-V to 20-V Supply-Voltage Range
- Low Supply Current . . . 3.5 mA Typ
- Adjustable Dead-Time Control, 0% to 100%
- 1.25-V Reference

description

The TL1454 is a dual-channel pulse-width-modulation (PWM) control circuit, primarily intended for low-power, dc/dc converters. Applications include LCD displays, backlight inverters, notebook com-

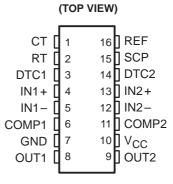
puters, and other products requiring small, high-frequency, dc/dc converters. Each PWM channel has its own error amplifier, PWM comparator, dead-time control comparator, and MOSFET driver. The voltage reference, oscillator, undervoltage lockout, and short-circuit protection are common to both channels.

Channel 1 is configured to drive n-channel MOSFETs in step-up or flyback converters, and channel 2 is configured to drive p-channel MOSFETs in step-down or inverting converters. The operating frequency is set with an external resistor and an external capacitor, and dead time is continuously adjustable from 0 to 100% duty cycle with a resistive divider network. Soft start can be implemented by adding a capacitor to the dead-time control (DTC) network. The error-amplifier common-mode input range includes ground, which allows the TL1454 to be used in ground-sensing battery chargers as well as voltage converters.

AVAILABLE OPTIONS

	P	ACKAGED DEVICEST		CHIP FORM
TA	SMALL OUTLINE (D)	PLASTIC DIP (N)	TSSOP (PW)	(Y)
-20°C to 85°C	TL1454CD	TL1454CN	TL1454CPWLE	TL1454Y
−40°C to 85°C	TL1454ID	TL1454IN		_

[†] The D package is available taped and reeled. Add the suffix R to the device name (e.g., TL1454CDR). The PW package is available only left-end taped and reeled (indicated by the LE suffix on the device type; e.g., TL1454CPWLE).



D, N OR PW PACKAGE



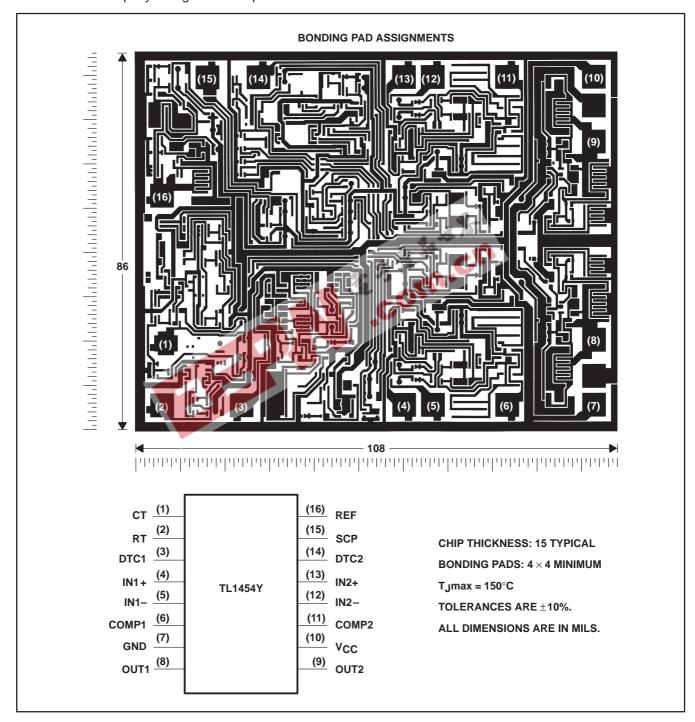
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functional block diagram **VCC** RT CT |10 2 | 1 16 REF 1.25 V Voltage 1.8 V REF 2.5 V To Internal Circuitry GND 7 1.2 V VCC osc **PWM** COMP1 Comparator 1 IN1 + 4 8 OUT1 IN1-Error **Amplifier 1** PWM COMP2 11 Comparator 2 IN2+ 13 VCC IN2-Error Amplifier 2 UVLO 9 OUT2 and SCP Latch SCP Comparator 2 0.65 V 0.65 V SCP Comparator 1 1.25 V 15 3 14 SCP DTC1 DTC2

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TL1454Y chip information

This chip, when properly assembled, displays characteristics similar to the TL1454C. Thermal compression or ultrasonic bonding may be used on the doped aluminum bonding pads. The chips may be mounted with conductive epoxy or a gold-silicon preform.



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theory of operation

reference voltage

A linear regulator operating from V_{CC} generates a 2.5-V supply for the internal circuits and the 1.25-V reference, which can source a maximum of 1 mA for external loads. A small ceramic capacitor (0.047 μ F to 0.1 μ F) between REF and ground is recommended to minimize noise pickup.

error amplifier

The error amplifier generates the error signal used by the PWM to adjust the power-switch duty cycle for the desired converter output voltage. The signal is generated by comparing a sample of the output voltage to the voltage reference and amplifying the difference. An external resistive divider connected between the converter output and ground, as shown in Figure 1, is generally required to obtain the output voltage sample.

The amplifier output is brought out on COMP to allow the frequency response of the amplifier to be shaped with an external RC network to stabilize the feedback loop of the converter. DC loading on the COMP output is limited to $45 \, \mu A$ (the maximum amplifier source current capability).

Figure 1 illustrates the sense-divider network and error-amplifier connections for converters with positive output voltages. The divider network is connected to the noninverting amplifier input because the PWM has a phase inversion; the duty cycle decreases as the error-amplifier output increases.

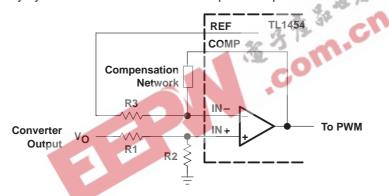


Figure 1. Sense Divider/Error Amplifier
Configuration for Converters with Positive Outputs

The output voltage is given by:

$$V_{O} = V_{ref} \left(1 + \frac{R1}{R2} \right)$$

where $V_{ref} = 1.25 \text{ V}$.

The dc source resistance of the error-amplifier inputs should be 10 k Ω or less and approximately matched to minimize output voltage errors caused by the input-bias current. A simple procedure for determining appropriate values for the resistors is to choose a convenient value for R3 (10 k Ω or less) and calculate R1 and R2 using:

$$R_1 = \frac{R_3 V_0}{V_0 - V_{ref}}$$

$$R_2 = \frac{R_3 V_0}{V_{ref}}$$



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error amplifier

R1 and R2 should be tight-tolerance ($\pm 1\%$ or better) devices with low and/or matched temperature coefficients to minimize output voltage errors. A device with a $\pm 5\%$ tolerance is suitable for R3.

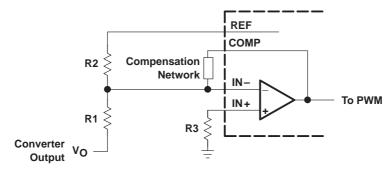


Figure 2. Sense Divider/Error Amplifier Configuration for Converters with Negative Outputs

Figure 2 shows the divider network and error-amplifier configuration for negative output voltages. In general, the comments for positive output voltages also apply for negative outputs. The output voltage is given by:

$$V_O = -\frac{R_1 V_{ref}}{R_2}$$

The design procedure for choosing the resistor value is to select a convenient value for R2 (instead of R3 in the procedure for positive outputs) and calculate R1 and R3 using:

$$R_1 = -\frac{R_2 V_0}{V_{ref}}$$

$$R_3 = \frac{R_1 R_2}{R_1 + R_2}$$

Values in the $10-k\Omega$ to $20-k\Omega$ range work well for R2. R3 can be omitted and the noninverting amplifier connected to ground in applications where the output voltage tolerance is not critical.

oscillator

The oscillator frequency can be set between 50 kHz and 2 MHz with a resistor connected between RT and GND and a capacitor between CT and GND (see Figure 3). Figure 6 is used to determine R_T and C_T for the desired operating frequency. Both components should be tight-tolerance, temperature-stable devices to minimize frequency deviation. A 1% metal-film resistor is recommended for R_T , and a 10%, or better, NPO ceramic capacitor is recommended for C_T .

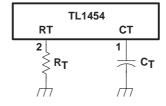


Figure 3. Oscillator Timing



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dead-time control (DTC) and soft start

The two PWM channels have independent dead-time control inputs so that the maximum power-switch duty cycles can be limited to less then 100%. The dead-time is set with a voltage applied to DTC; the voltage is typically obtained from a resistive divider connected between the reference and ground as shown in Figure 4. Soft start is implemented by adding a capacitor between REF and DTC.

The voltage, V_{DT}, required to limit the duty cycle to a maximum value is given by:

$$V_{DT} = V_{O(max)} - D(V_{O(max)} - V_{O(min)}) - 0.65$$

where $V_{O(max)}$ and $V_{O(min)}$ are obtained from Figure 9, and D is the maximum duty cycle.

Predicting the regulator startup or rise time is complicated because it depends on many variables, including: input voltage, output voltage, filter values, converter topology, and operating frequency. In general, the output will be in regulation within two time constants of the soft-start circuit. A five-to-ten millisecond time constant usually works well for low-power converters.

The DTC input can be grounded in applications where achieving a 100% duty cycle is desirable, such as a buck converter with a very low input-to-output differential voltage. However, grounding DTC prevents the implementation of soft start, and the output voltage overshoot at power-on is likely to be very large. A better arrangement is to omit R_{DT1} (see Figure 4) and choose R_{DT2} = 47 k Ω . This configuration ensures that the duty cycle can reach 100% and still allows the designer to implement soft start using C_{SS} .

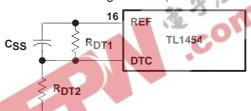


Figure 4. Dead-Time Control and Soft Start

PWM comparator

Each of the PWM comparators has dual inverting inputs. One inverting input is connected to the output of the error amplifier; the other inverting input is connected to the DTC terminal. Under normal operating conditions, when either the error-amplifier output or the dead-time control voltage is higher than that for the PWM triangle wave, the output stage is set inactive (OUT1 low and OUT2 high), turning the external power stage off.

undervoltage-lockout (UVLO) protection

The undervoltage-lockout circuit turns the output circuit off and resets the SCP latch whenever the supply voltage drops too low (to approximately 2.9 V) for proper operation. A hysteresis voltage of 200 mV eliminates false triggering on noise and chattering.

short-circuit protection (SCP)

The TL1454 SCP function prevents damage to the power switches when the converter output is shorted to ground. In normal operation, SCP comparator 1 clamps SCP to approximately 185 mV. When one of the converter outputs is shorted, the error amplifier output (COMP) will be driven below 1 V to maximize duty cycle and force the converter output back up. When the error amplifier output drops below 1 V, SCP comparator 1 releases SCP, and capacitor, C_{SCP} , which is connected between SCP and GND, begins charging. If the error-amplifier output rises above 1 V before C_{SCP} is charged to 1 V, SCP comparator 1 discharges C_{SCP} and normal operation resumes. If C_{SCP} reaches 1 V, SCP comparator 2 turns on and sets the SCP latch, which turns off the output drives and resets the soft-start circuit. The latch remains set until the supply voltage is lowered to 2 V or less, or C_{SCP} is discharged externally.



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short-circuit protection (SCP) (continued)

The SCP time-out period must be greater than the converter start-up time or the converter will not start. Because high-value capacitor tolerances tend to be $\pm 20\%$ or more and IC resistor tolerances are loose as well, it is best to choose an SCP time-out period 10-to-15 times greater than the converter startup time. The value of C_{SCP} may be determined using Figure 6, or it can be calculated using:

$$C_{SCP} = \frac{T_{SCP}}{80.3}$$

where C_{SCP} is in μF and T_{SCP} is the time-out period in ms.

output stage

The output stage of the TL1454 is a totem-pole output with a maximum source/sink current rating of 40 mA and a voltage rating of 20 V. The output is controlled by a complementary output AND gate and is turned on (sourcing current for OUT1, sinking current for OUT2) when all the following conditions are met: 1) the oscillator triangle wave voltage is higher than both the DTC voltage and the error-amplifier output voltage, 2) the undervoltage-lockout circuit is inactive, and 3) the short-circuit protection circuit is inactive.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	
Error amplifier input voltage: IN1+, IN1-, IN2+, IN2-	
Output voltage: OUT1, OUT2	20 V
Continuous output current: OUT1, OUT2	±200 mA
Peak output current: OUT1, OUT2	1 A
Continuous total dissipation	See Dissination Rating Table
Continuodo total dicolpation	occ biooipation rating lable
Operating free-air temperature range, T _A : C suffix	ı
Operating free-air temperature range, TA: C suffix	i G
Operating free-air temperature range, TA: C suffix	–20°C to 85°C –40°C to 85°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network GND.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25^{\circ}C$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW	494 mW
N	1250 mW	10.0 mW/°C	800 mW	650 mW
PW	500 mW	4.0 mW/°C	320 mW	260 mW

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recommended operating conditions

			MIN	MAX	UNIT
Supply voltage, V _{CC}			3.6	20	V
Error amplifier common-mode input volta	tage		-0.2	1.45	V
Output voltage, VO				20	V
Output current, IO				±40	mA
COMP source current				-45	μΑ
COMP sink current				100	μΑ
Reference output current				1	mA
COMP dc load resistance			100		kΩ
Timing capacitor, C _T			10	4000	pF
Timing resistor, R _T			5.1	100	kΩ
Oscillator frequency		50	2000	kHz	
Operating free six temperature T.		-20	85	°C	
Operating free-air temperature, TA	Т	L1454I	-40	85	, C

electrical characteristics over recommended operating free-air temperature range, V_{CC} = 6 V, f_{osc} = 500 kHz (unless otherwise noted) reference

	PARAMETER	TEST CONDITIONS		UNIT		
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNII
٧.	Output voltage, REF	$I_{O} = 1 \text{ mA}, T_{A} = 25^{\circ}\text{C}$	1.23	1.25	1.28	V
V _{ref}	Output voltage, NEP	$I_O = 1 \text{ mA}$	1.2		1.31	V
	Input regulation	$V_{OC} = 3.6 \text{ V to } 20 \text{ V}, \qquad I_{O} = 1 \text{ mA}$		2	6	mV
	Output regulation	I _O = 0.1 mA to 1 mA		1	7.5	mV
	Output voltage shows a with temporative	$T_A = T_{A(min)}$ to 25°C, $I_O = 1$ mA	-12.5	-1.25	12.5	mV
Output voltage chan <mark>ge wi</mark> th temperature		$T_A = 25^{\circ}C \text{ to } 85^{\circ}C, \qquad I_O = 1 \text{ mA}$	-12.5	-2.5	12.5	IIIV
los	Short-circuit output current	V _{ref} = 0 V		30		mA

undervoltage lockout (UVLO)

PARAMETER		TEST CONDITIONS	•	UNIT		
		TEST CONDITIONS	MIN	TYP	MAX	ONIT
V _{IT+}	Positive-going threshold voltage			2.9		V
VIT-	Negative-going threshold voltage	T _A = 25°C		2.7		V
V _{hys}	Hysteresis, V _{IT+} – V _{IT}		100	200		mV

short-circuit protection (SCP)

	PARAMETER	TEST CONDITIONS		UNIT		
	FARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{IT}	Input threshold voltage	T _A = 25°C	0.95	1	1.05	V
V _{stby} †	Standby voltage	No pullup	140	185	230	mV
V _I (latched)	Latched-mode input voltage	No pullup		60	120	mV
VIT(COMP)	Comparator threshold voltage	COMP1, COMP2		1		V
	Input source current	$T_A = 25^{\circ}C, V_{O(SCP)} = 0$	-5	-15	-20	μΑ

[†] This symbol is not presently listed within EIA/JEDEC standards for semiconductor symbology.



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electrical characteristics over recommended operating free-air temperature range, V_{CC} = 6 V, f_{osc} = 500 kHz (unless otherwise noted) (continued)

oscillator

	PARAMETER	TEST COND	TEST CONDITIONS			TL1454			
	FARAINETER	TEST COND	ITIONS	MIN	TYP	MAX	UNIT		
fosc	Frequency	C _T = 120 pF,	$R_T = 10 \text{ k}\Omega$		500		kHz		
	Standard deviation of frequency				50		kHz		
	Frequency change with voltage	$V_{CC} = 3.6 \text{ V to } 20 \text{ V},$	$T_A = 25^{\circ}C$		5		kHz		
	Francisco change with temperature	$T_A = T_{A(min)}$ to 25°C			-2	±20	lel I=		
	Frequency change with temperature	T _A = 25°C to 85°C			-10	±20	kHz		
	Maximum ramp voltage				1.8		V		
	Minimum ramp voltage				1.1		V		

dead-time control (DTC)

PARAMETER		TEST CONDITIONS	7	UNIT		
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNII
\/	Input threshold voltage	Duty cycle = 0%	1	1.1	1.2	V
VIT	input threshold voltage	Duty cycle = 100%	0.4	0.5	0.6	V
V _I (latched)	Latched-mode input voltage	43		1.2		V
I _{IB}	Common-mode input bias current	DTC1, IN1+ ≈ 1.2 V			4	μΑ
	Latched-mode (source) current	T _A = 25°C		-100		μΑ

error-amplifier

	PARAMETER	TEST CONDITIONS	TL1454			UNIT
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNII
VIO	Input offset voltage				6	mV
lio	Input offset current	$V_O = 1.25 \text{ V}, V_{IC} = 1.25 \text{ V}$			100	nA
I _{IB}	Input bias current			-160	-500	nA
VICR	Input voltage range	V _{CC} = 3.6 V to 20 V	-0.2 to 1.40			V
Ay	Open-loop voltage gain	R _{FB} = 200 kΩ	70	80		dB
	Unity-gain bandwidth			3		MHz
CMRR	Common-mode rejection ratio		60	80		dB
V _{OM(max)}	Positive output voltage swing		2.3	2.43		V
VOM(min)	Negative output voltage swing			0.63	0.8	V
l _{O+}	Output sink current	$V_{ID} = -0.1 \text{ V}, V_{O} = 1.20 \text{ V}$	0.1	0.5		mA
l _O _	Output source current	$V_{ID} = 0.1 \text{ V}, \qquad V_{O} = 1.80 \text{ V}$	-45	-70		μΑ

output

	PARAMETER	TEST CONDITIONS	TL1454			UNIT
	FARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Vou	High lovel output voltage	$I_O = -8 \text{ mA}$	V _{CC} -2	4.5		V
VOH High-level output voltage		$I_O = -40 \text{ mA}$	V _{CC} -2	4.4		V
Val	Low-level output voltage	I _O = 8 mA		0.1	0.4	V
VOL	Low-level output voltage	I _O = 40 mA		1.8	2.5	V
t _{rv}	Output voltage rise time	C _L = 2000 pF, T _A = 25°C		220		ns
tfV	Output voltage fall time	CL = 2000 μr, TA = 25 C		220	·	115



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electrical characteristics over recommended operating free-air temperature range, V_{CC} = 6 V, f_{osc} = 500 kHz (unless otherwise noted) (continued)

supply current

PARAMETER		TEST COM	TEST CONDITIONS		TL1454		
	PARAMETER	TEST CON	DITIONS	MIN	TYP	MAX	UNIT
ICC(stby)	Standby supply current	RT open, CT = 1.5 V, No load, V _O (COMP1, COMP2) = 1.25 V,			3.1	6	mA
ICC(average)	Average supply current	$R_T = 10 \text{ k}\Omega$, 50% duty cycle,	C _T = 120 pF, Outputs open		3.5	7	mA

electrical characteristics, V_{CC} = 6 V, f_{osc} = 500 kHz, T_A = 25°C (unless otherwise noted)

reference

PARAMETER		TEST CONDITIONS	TL1454Y	UNIT
		TEST CONDITIONS	MIN TYP MAX	I UNII
V _{ref}	Output voltage, REF	I _O = 1 mA,	1.25	V
	Input regulation	$V_{OC} = 3.6 \text{ V to } 20 \text{ V}, \qquad I_{O} = 1 \text{ mA}$	2	mV
	Output regulation	I _O = 0.1 mA to 1 mA	1	mV
	Output voltage change with temperature	I _O = 1 mA	-1.25	mV
Output voltage change with temperature		I _O = 1 mA	-2.5	IIIV
los	Short-circuit output current	V _{ref} = 0 V	30	mA

undervoltage lockout (UVLO)

DADAMETED			TEST CONDITIONS		TL1454Y			UNIT	
	PARAMETER		М.	TEST CONDITIONS	MIN	TYP	MAX	CIVIT	
V _{IT+}	Positive-going threshold voltage	7					2.9		V
V _{IT} -	Negative-going threshold voltage						2.7		V
V _{hys}	Hysteresis, V _{IT+} - V _{IT-}			1			200		mV

short-circuit protection (SCP)

PARAMETER		TEST CONDITIONS	Т	UNIT		
		TEST CONDITIONS	MIN	TYP	MAX	UNIT
VIT	Input threshold voltage			1		V
∨ _{stby} †	Standby voltage	No pullup		185		mV
V _I (latched)	Latched-mode input voltage	No pullup		60		mV
VIT(COMP)	Comparator threshold voltage	COMP1, COMP2		1		V
	Input source current	$V_{O(SCP)} = 0$		-15		μΑ

[†] This symbol is not presently listed within EIA/JEDEC standards for semiconductor symbology.

oscillator

PARAMETER		TEST CONDITIONS	Т	UNIT		
		TEST CONDITIONS	MIN	TYP	MAX	UNII
fosc	Frequency	$C_T = 120 \text{ pF}, \qquad R_T = 10 \text{ k}\Omega$		500		kHz
	Standard deviation of frequency			50		kHz
	Frequency change with voltage	V _{CC} = 3.6 V to 20 V		5		kHz
				-2		1-1 1-
	Frequency change with temperature			-10		kHz
	Maximum ramp voltage			1.8		V
	Minimum ramp voltage			1.1		V



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electrical characteristics, V_{CC} = 6 V, f_{osc} = 500 kHz, T_A = 25°C (unless otherwise noted) (continued) dead-time control (DTC)

	PARAMETER	TEST CONDITIONS		TL1454Y		
FARAWETER		TEST CONDITIONS	MIN TYP		MAX	UNIT
\/	Input threshold voltage	Duty cycle = 0%	Duty cycle = 0% 1.1			
VIT	input tiffeshold voltage	Duty cycle = 100%		0.5		V
V _I (latched)	Latched-mode input voltage			1.2		V
	Latched-mode (source) current			-100		μΑ

error-amplifier

	PARAMETER	TEST CONDITIONS	TL1454Y	UNIT
	FARAMETER	TEST CONDITIONS	MIN TYP MAX	ONII
I _{IB}	Input bias current	$V_O = 1.25 \text{ V}, \qquad V_{IC} = 1.25 \text{ V}$	-160	nA
Ay	Open-loop voltage gain	R _{FB} = 200 kΩ	80	dB
	Unity-gain bandwidth		3	MHz
CMRR	Common-mode rejection ratio	.4	80	dB
V _{OM(max)}	Positive output voltage swing	- A 75	2.43	V
VOM(min)	Negative output voltage swing	2 32	0.63]
I _{O+}	Output sink current	$V_{ID} = -0.1 \text{ V}, \qquad V_{O} = 1.20 \text{ V}$	0.5	mA
I _O _	Output source current	$V_{ID} = 0.1 \text{ V}, \qquad V_{O} = 1.80 \text{ V}$	-70	μА

output

	PARAMETER	A = I	TEST CONDITIONS	TL1454Y	UNIT
	PARAMETER			MIN TYP MAX	UNII
VOH	High-level output voltage		$I_O = -8 \text{ mA}$	4.5	
	r light-level output voltage		$I_O = -40 \text{ mA}$	4.4	ľ
Val	Low lovel output voltage		IO = 8 mA	0.1	
VOL	Low-level output voltage	Low-level output voltage	I _O = 40 mA	1.8]
t _{rv}	Output voltage rise time		C 2000 pE	220	
t _{fV}	Output voltage fall time		C _L = 2000 pF	220	ns

supply current

	PARAMETER	TEST CONDITIONS	Т	L1454Y		UNIT
FARAMETER		TEST CONDITIONS	MIN TYP M			UNIT
I _{CC(stby)}	Standby supply current	RT open, CT = 1.5 V, No load, V _O (COMP1, COMP2) = 1.25 V,		3.1		mA
ICC(average)	Average supply current	$R_T = 10 \text{ k}\Omega,$ $C_T = 120 \text{ pF},$ 50% duty cycle, Outputs open		3.5	·	mA

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PARAMETER MEASUREMENT INFORMATION

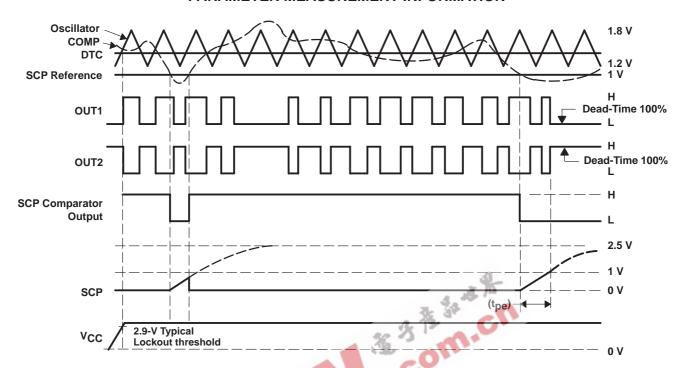


Figure 5. Timing Diagram

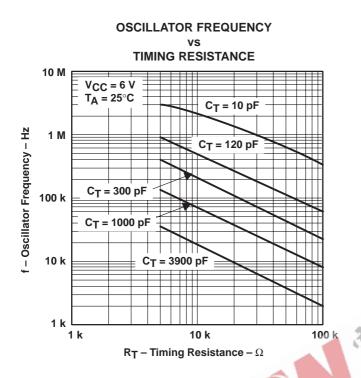
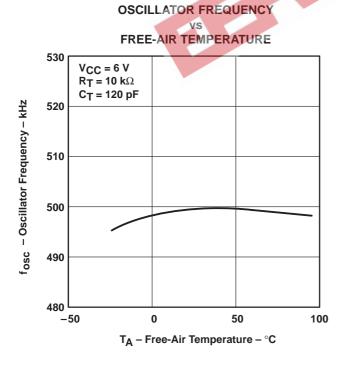


Figure 6

Figure 7



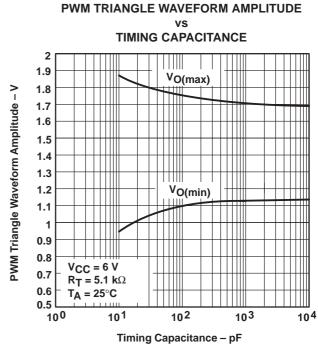


Figure 8 Figure 9

DTC INPUT THRESHOLD VOLTAGE FREE-AIR TEMPERATURE $V_{CC} = 6 V$ $R_T = 5.1 \text{ k}\Omega$ $C_T = 1000 pF$ 1.2 DTC Input Threshold Voltage - V VIT (0% Duty Cycle) 1 8.0 0.6 V_{IT} (100% Duty Cycle) 0.4 100 50 -50 T_A – Free-Air Temperature – $^{\circ}C$

Figure 10

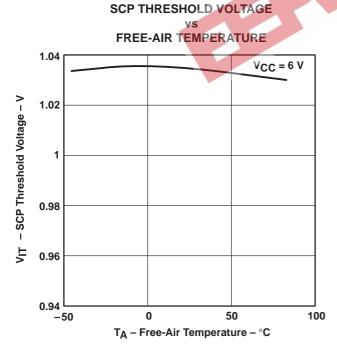


Figure 12

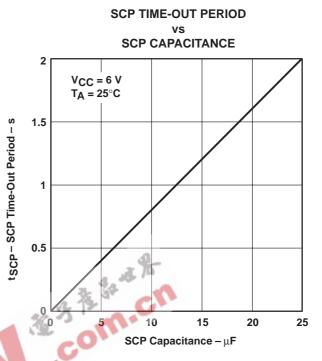


Figure 11

SCP LATCH RESET VOLTAGE vs FREE-AIR TEMPERATURE

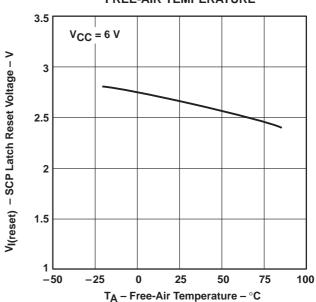
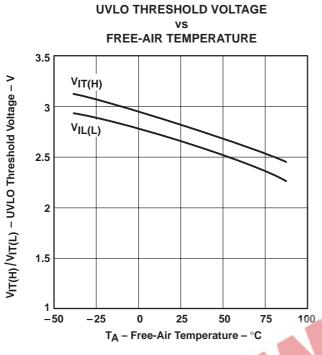


Figure 13





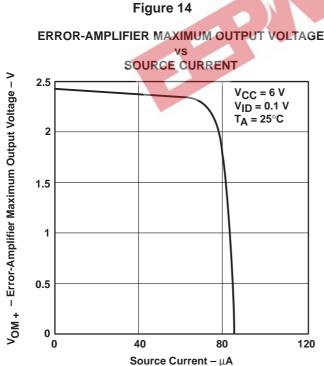


Figure 16

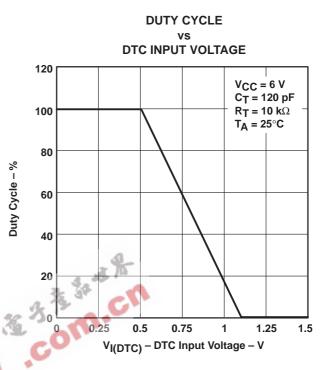


Figure 15

ERROR-AMPLIFIER MINIMUM OUTPUT VOLTAGE

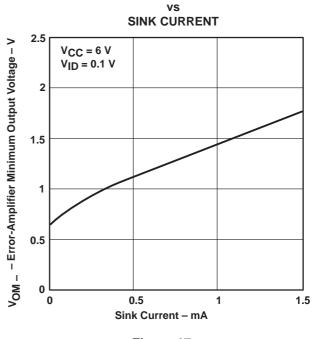
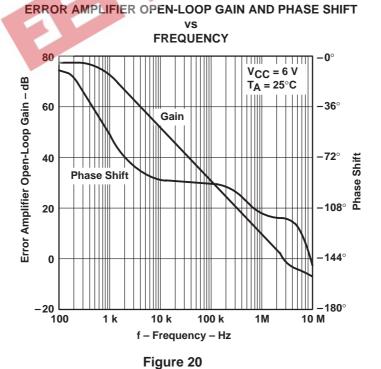


Figure 17

ERROR AMPLIFIER MAXIMUM ERROR-AMPLIFIER MINIMUM OUTPUT VOLTAGE SWING PEAK-TO-PEAK OUTPUT VOLTAGE SWING vs vs VOM+ - Error-Ampplifier Minimum Output Voltage Swing - V **FREQUENCY** FREE-AIR TEMPERATURE 2.5 0.8 $V_{CC} = 6 V$ V_O(PP) – Error Amplifier Maximum Peak-to-Peak Output Voltage Swing – V VCC = 6 VTA = 25°C No Load **Amplifier 1** 0.7 0.6 1.5 0.5 1 0.4 0.5 0 0.3 1 k 10 k 1M 10 M 100 M 25 75 100 T_A – Free-Air Temperature – °C f - Frequency - Hz

Figure 19



ERROR-AMPLIFIER POSITIVE OUTPUT VOLTAGE SWING

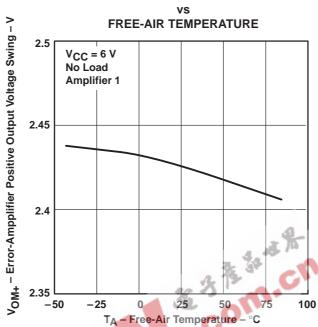


Figure 21

HIGH-LEVEL OUTPUT VOLTAGE

OUTPUT CURRENT

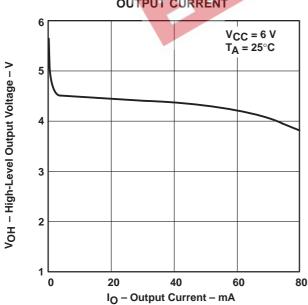


Figure 22

HIGH-LEVEL OUTPUT VOLTAGE

vs

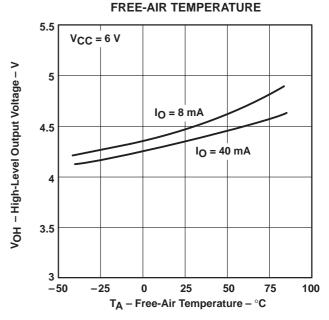


Figure 23

6

5

3

0

Vol - Low-Level Output Voltage - V

TYPICAL CHARACTERISTICS

VS LOW-LEVEL OUTPUT CURRENT VCC = 6 V TA = 25°C

LOW-LEVEL OUTPUT VOLTAGE

Figure 24

LOW-LEVEL OUTPUT VOLTAGE

IOL - Low-Level Output Current - mA

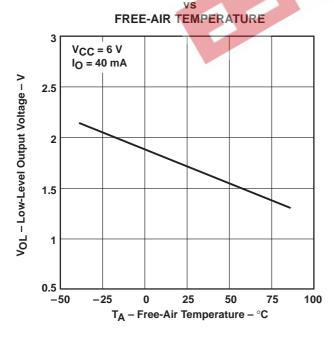


Figure 26

LOW-LEVEL OUTPUT VOLTAGE vs FREE-AIR TEMPERATURE

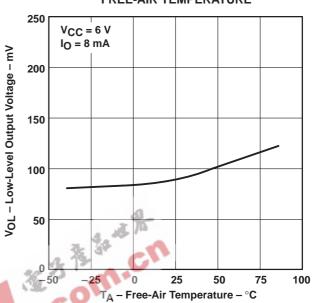


Figure 25

AVERAGE SUPPLY CURRENT vs

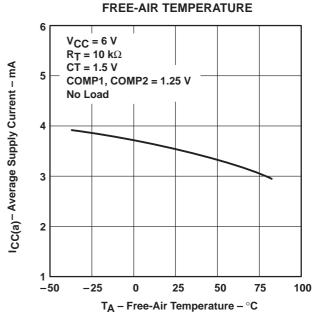


Figure 27

STANDBY SUPPLY CURRENT SUPPLY VOLTAGE VCC = 6 VRT = Open CT = 1.5 V ICC(stby)- Standby Supply Current - mA **COMP1, COMP2 = 1.25 V** No Load T_A = 25°C 3 2 0 5 25 10 15 20 V_{CC} - Supply Voltage - V

STANDBY SUPPLY CURRENT vs
FREE-AIR TEMPERATURE

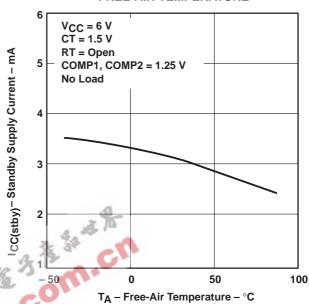
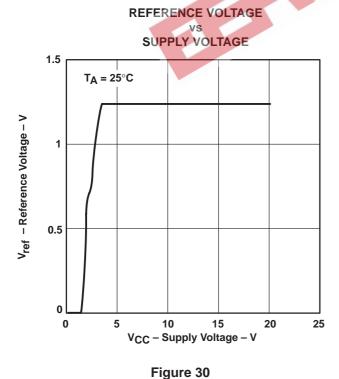
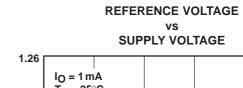


Figure 28

Figure 29





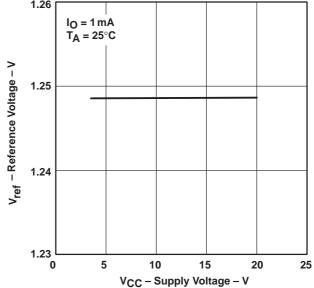


Figure 31

REFERENCE VOLTAGE FREE-AIR TEMPERATURE

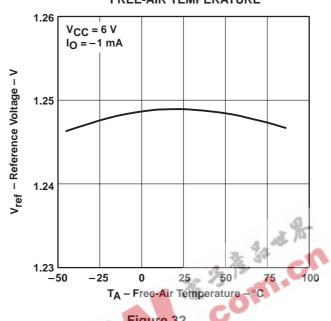


Figure 32



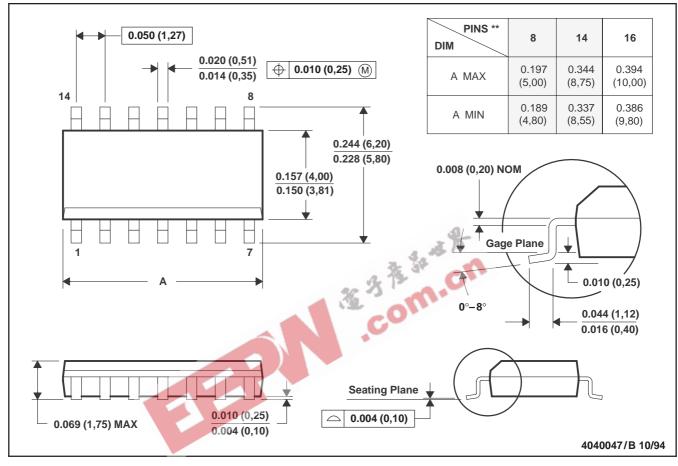
SLVS086B - APRIL 1995 - REVISED NOVEMBER 1997

MECHANICAL DATA

D (R-PDSO-G**)

14 PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Four center pins are connected to die mount pad

E. Falls within JEDEC MS-012

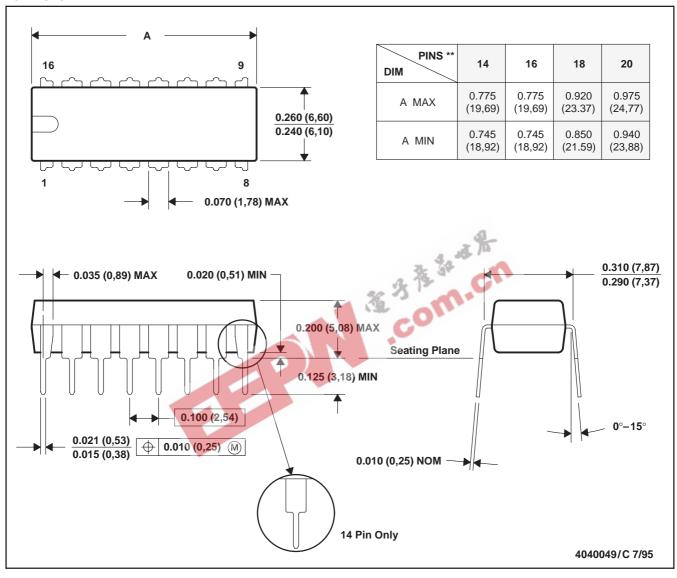
SLVS086B - APRIL 1995 - REVISED NOVEMBER 1997

MECHANICAL DATA

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-001 (20-pin package is shorter than MS-001)



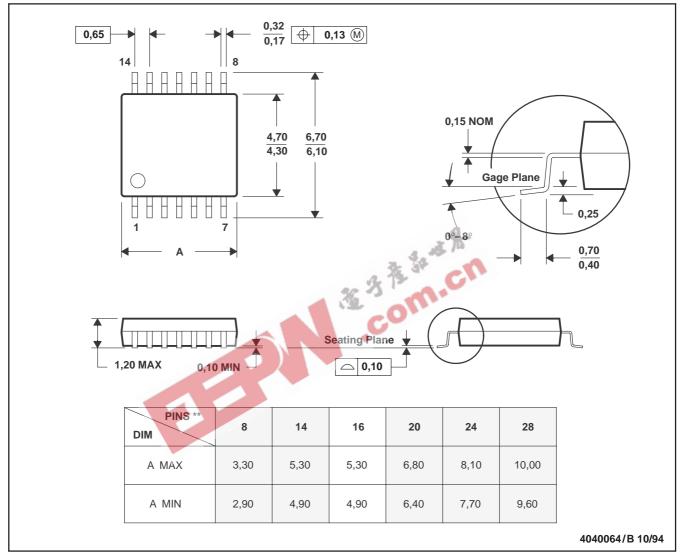
SLVS086B - APRIL 1995 - REVISED NOVEMBER 1997

MECHANICAL DATA

PW (R-PDSO-G**)

14 PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

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